

















# **Datasheet**

# **AUO**

P495IVN01.0

The information contained in this document has been carefully researched and is, to the best of our knowledge, accurate. However, we assume no liability for any product failures or damages, immediate or consequential, resulting from the use of the information provided herein. Our products are not intended for use in systems in which failures of product could result in personal injury. All trademarks mentioned herein are property of their respective owners. All specifications are subject to change without notice.



# Model Name: P495IVN01.0

Issue Date: 2020/02/11

(\*)Preliminary Specifications

( )Final Specifications

Customer Signatu	ire	Date	AUO	Date					
Approved By	For D	202001	Approval By PM Director CT Wu	TWu*					
Note		Con	Reviewed By RD Director Young Yang	名到					
		ISTEC IN	Reviewed By Project Leader  Amelia Huang						
	*	P	Prepared By PM Bryan Chu	大学					



# Contents

2. Absolute Maximum Ratings       6         3. Optical Specification       7         4. Interface Specification       10         4.1 Input power       10         4.2 Input Connection       11         4.3 Input Data Format       13         4.3.1 LVDS color data mapping       13         4.3.2 Color Input Data Reference       14         5. Signal Timing Specification       15         5.1 Input Timing       15         5.1.1. Timing table       15         5.1.2. Signal Timing Waveform       16         5.2 Input interface characteristics       17         5.3 Power Sequence for LCD       19         6. Backlight Specification       20         6.1 Electrical specification       20         6.2 Input Pin Assignment       21         6.3 Power Sequence for Backlight       23         7. Mechanical Characteristics       24         8. Reliability Test Items       27         9.1 Safety       28         9.2 EMC       28         10. Packing       29         10.1 Definition of Label       29         10.2 Packing Methods       30         10.3 Pallet and Shipment Information       31         11. Mounting Preca	1.		eneral Descriptioneneral Description	
4.1       Input power       10         4.2       Input Connection       11         4.3       Input Data Format       13         4.3.1       LVDS color data mapping       13         4.3.2       Color Input Data Reference       14         5.       Signal Timing Specification       15         5.1       Input Timing       15         5.1.1       Timing Bable       15         5.1.2       Signal Timing Waveform       16         5.2       Input interface characteristics       17         5.3       Power Sequence for LCD       19         6.       Backlight Specification       20         6.1       Electrical specification       20         6.2       Input Pin Assignment       21         6.3       Power Sequence for Backlight       23         7.       Mechanical Characteristics       24         8.       Reliability Test Items       27         9.       International Standard       28         9.1       Safety       28         9.2       EMC       28         10.       Packing       29         10.1       Definition of Label       29         10.2 <td>2.</td> <td>Al</td> <td>bsolute Maximum Ratings</td> <td>. 6</td>	2.	Al	bsolute Maximum Ratings	. 6
4.1       Input Data Format       11         4.2       Input Data Format       13         4.3.1       LVDS color data mapping       13         4.3.2       Color Input Data Reference       14         5.       Signal Timing Specification       15         5.1       Input Timing       15         5.1.1       Timing table       15         5.2       Input interface characteristics       17         5.3       Power Sequence for LCD       19         6.       Backlight Specification       20         6.1       Electrical specification       20         6.2       Input Pin Assignment       21         6.3       Power Sequence for Backlight       23         7       Mechanical Characteristics       24         8       Reliability Test Items       27         9       International Standard       28         9.1       Safety       28         9.2       EMC       28         10       Packing       29         10.1       Definition of Label       29         10.2       Packing Methods       30         10.3       Pallet and Shipment Information       31 <t< td=""><td>3.</td><td>0</td><td>ptical Specification</td><td>. 7</td></t<>	3.	0	ptical Specification	. 7
4.2       Input Connection       11         4.3       Input Data Format       13         4.3.1       LVDS color data mapping       13         4.3.2       Color Input Data Reference       14         5.       Signal Timing Specification       15         5.1       Input Timing       15         5.1.1       Timing table       15         5.1.2       Signal Timing Waveform       16         5.2       Input interface characteristics       17         5.3       Power Sequence for LCD       19         6       Backlight Specification       20         6.1       Electrical specification       20         6.2       Input Pin Assignment       21         6.3       Power Sequence for Backlight       21         6.3       Power Sequence for Backlight       23         7       Mechanical Characteristics       24         8       Reliability Test Items       27         9       International Standard       28         9.1       Safety       28         9.2       EMC       28         10       Packing       29         10.1       Definition of Label       29	4.	In	terface Specification	10
4.3       Input Data Format       13         4.3.1       LVDS color data mapping       13         4.3.2       Color Input Data Reference       14         5.       Signal Timing Specification       15         5.1       Input Timing       15         5.1.1.       Timing table       15         5.1.2.       Signal Timing Waveform       16         5.2       Input interface characteristics       17         5.3       Power Sequence for LCD       19         6.       Backlight Specification       20         6.1       Electrical specification       20         6.2       Input Pin Assignment       21         6.3       Power Sequence for Backlight       23         7.       Mechanical Characteristics       24         8.       Reliability Test Items       27         9.       International Standard       28         9.1       Safety       28         9.2       EMC       28         10.       Packing       29         10.1       Definition of Label       29         10.2       Packing Methods       30         10.3       Pallet and Shipment Information       31	4.	1	Input power	10
4.3.1       LVDS color data mapping       13         4.3.2       Color Input Data Reference       14         5.       Signal Timing Specification       15         5.1       Input Timing       15         5.1.1.       Timing table       16         5.1.2.       Signal Timing Waveform       16         5.2.       Input interface characteristics       17         5.3       Power Sequence for LCD       19         6.       Backlight Specification       20         6.1       Electrical specification       20         6.2       Input Pin Assignment       21         6.3       Power Sequence for Backlight       23         7.       Mechanical Characteristics       24         8.       Reliability Test Items       27         9.       International Standard       28         9.1       Safety       28         9.2       EMC       28         10.       Packing       29         10.1       Definition of Label       29         10.2       Packing Methods       30         10.3       Pallet and Shipment Information       31         11.       Precautions       32	4.			
4.3.2       Color Input Data Reference       14         5.       Signal Timing Specification       15         5.1       Input Timing       15         5.1.1.       Timing table       15         5.1.2.       Signal Timing Waveform       16         5.2       Input interface characteristics       17         5.3       Power Sequence for LCD       19         6.       Backlight Specification       20         6.1       Electrical specification       20         6.2       Input Pin Assignment       21         6.3       Power Sequence for Backlight       23         7.       Mechanical Characteristics       24         8.       Reliability Test Items       27         9.       International Standard       28         9.1       Safety       28         9.2       EMC       28         10.       Packing       29         10.1       Definition of Label       29         10.2       Packing Methods       30         10.3       Pallet and Shipment Information       31         11.       Precautions       32         11.1.       Mounting Precautions       32	4.	3	Input Data Format	13
5. Signal Timing Specification       15         5.1 Input Timing       15         5.1.1. Timing table       15         5.1.2. Signal Timing Waveform       16         5.2 Input interface characteristics       17         5.3 Power Sequence for LCD       19         6. Backlight Specification       20         6.1 Electrical specification       20         6.2 Input Pin Assignment       21         6.3 Power Sequence for Backlight       23         7. Mechanical Characteristics       24         8. Reliability Test Items       27         9. International Standard       28         9.1 Safety       28         9.2 EMC       28         10. Packing       29         10.1 Definition of Label       29         10.2 Packing Methods       30         10.3 Pallet and Shipment Information       31         11. Precautions       32         11.1. Mounting Precautions       32         11.2 Operating Precautions       32         11.3. Operating Condition for Public Information Display       33         11.5. Precautions for Strong Light Exposure       34         11.5. Handling Precautions for Protection Film       34         11.8. Dust Resistance		4.	3.1 LVDS color data mapping	13
5.1       Input Timing       15         5.1.1.       Timing table       15         5.1.2.       Signal Timing Waveform       16         5.2       Input interface characteristics       17         5.3       Power Sequence for LCD       19         6.       Backlight Specification       20         6.1       Electrical specification       20         6.2       Input Pin Assignment       21         6.3       Power Sequence for Backlight       23         7.       Mechanical Characteristics       24         8.       Reliability Test Items       27         9.       International Standard       28         9.1       Safety       28         9.2       EMC       28         10.       Packing       29         10.1       Definition of Label       29         10.2       Packing Methods       30         10.3       Pallet and Shipment Information       31         11.       Precautions       32         11.1.       Mounting Precautions       32         11.2.       Operating Precautions       32         11.3.       Operating Condition for Public Information Display       33		4.	3.2 Color Input Data Reference	14
5.1.1. Timing table       15         5.1.2. Signal Timing Waveform       16         5.2 Input interface characteristics       17         5.3 Power Sequence for LCD       19         6. Backlight Specification       20         6.1 Electrical specification       20         6.2 Input Pin Assignment       21         6.3 Power Sequence for Backlight       23         7. Mechanical Characteristics       24         8. Reliability Test Items       27         9. International Standard       28         9.1 Safety       28         9.2 EMC       28         10. Packing       29         10.1 Definition of Label       29         10.2 Packing Methods       30         10.3 Pallet and Shipment Information       31         11. Precautions       32         11.1. Mounting Precautions       32         11.2. Operating Precautions       32         11.3. Operating Condition for Public Information Display       33         11.4. Electrostatic Discharge Control       33         11.5. Precautions for Strong Light Exposure       34         11.6. Storage       34         11.7. Handling Precautions for Protection Film       34         11.8. Dust Resistance	5.			
5.1.2. Signal Timing Waveform       16         5.2 Input interface characteristics       17         5.3 Power Sequence for LCD       19         6. Backlight Specification       20         6.1 Electrical specification       20         6.2 Input Pin Assignment       21         6.3 Power Sequence for Backlight       23         7. Mechanical Characteristics       24         8. Reliability Test Items       27         9. International Standard       28         9.1 Safety       28         9.2 EMC       28         10. Packing       29         10.1 Definition of Label       29         10.2 Packing Methods       30         10.3 Pallet and Shipment Information       31         11. Precautions       32         11.1. Mounting Precautions       32         11.2 Operating Precautions       32         11.3. Operating Condition for Public Information Display       33         11.4. Electrostatic Discharge Control       33         11.5. Precautions for Strong Light Exposure       34         11.6. Storage       34         11.7. Handling Precautions for Protection Film       34         11.8. Dust Resistance       34	5.	1		
5.2       Input interface characteristics       17         5.3       Power Sequence for LCD       19         6.       Backlight Specification       20         6.1       Electrical specification       20         6.2       Input Pin Assignment       21         6.3       Power Sequence for Backlight       23         7.       Mechanical Characteristics       24         8.       Reliability Test Items       27         9.       International Standard       28         9.1       Safety       28         9.2       EMC       28         10.       Packing       29         10.1       Definition of Label       29         10.2       Packing Methods       30         10.3       Pallet and Shipment Information       31         11.       Precautions       32         11.1.       Mounting Precautions       32         11.2.       Operating Precautions       32         11.3.       Operating Condition for Public Information Display       33         11.4.       Electrostatic Discharge Control       33         11.5.       Precautions for Strong Light Exposure       34         11.6.       Stor		5.	1.1. Timing table	15
5.3       Power Sequence for LCD       19         6.       Backlight Specification       20         6.1       Electrical specification       20         6.2       Input Pin Assignment       21         6.3       Power Sequence for Backlight       23         7.       Mechanical Characteristics       24         8.       Reliability Test Items       27         9.       International Standard       28         9.1       Safety       28         9.2       EMC       28         10.       Packing       29         10.1       Definition of Label       29         10.2       Packing Methods       30         10.3       Pallet and Shipment Information       31         11.       Precautions       32         11.1.       Mounting Precautions       32         11.2.       Operating Precautions       32         11.3.       Operating Condition for Public Information Display       33         11.4.       Electrostatic Discharge Control       33         11.5.       Precautions for Strong Light Exposure       34         11.6.       Storage       34         11.7.       Handling Precautions for P		_		
6.       Backlight Specification       20         6.1       Electrical specification       20         6.2       Input Pin Assignment       21         6.3       Power Sequence for Backlight       23         7.       Mechanical Characteristics       24         8.       Reliability Test Items       27         9.       International Standard       28         9.1       Safety       28         9.2       EMC       28         10.       Packing       29         10.1       Definition of Label       29         10.2       Packing Methods       30         10.3       Pallet and Shipment Information       31         11.       Precautions       32         11.1.       Mounting Precautions       32         11.2.       Operating Precautions       32         11.3.       Operating Condition for Public Information Display       33         11.4.       Electrostatic Discharge Control       33         11.5.       Precautions for Strong Light Exposure       34         11.7.       Handling Precautions for Protection Film       34         11.8.       Dust Resistance       34	5.	2	Input interface characteristics	17
6.1       Electrical specification       20         6.2       Input Pin Assignment       21         6.3       Power Sequence for Backlight       23         7.       Mechanical Characteristics       24         8.       Reliability Test Items       27         9.       International Standard       28         9.1       Safety       28         9.2       EMC       28         10.       Packing       29         10.1       Definition of Label       29         10.2       Packing Methods       30         10.3       Pallet and Shipment Information       31         11.       Precautions       32         11.1.       Mounting Precautions       32         11.2.       Operating Precautions       32         11.3.       Operating Condition for Public Information Display       33         11.4.       Electrostatic Discharge Control       33         11.5.       Precautions for Strong Light Exposure       34         11.6.       Storage       34         11.7.       Handling Precautions for Protection Film       34         11.8.       Dust Resistance       34	5.	3	Power Sequence for LCD	19
6.1       Electrical specification       20         6.2       Input Pin Assignment       21         6.3       Power Sequence for Backlight       23         7.       Mechanical Characteristics       24         8.       Reliability Test Items       27         9.       International Standard       28         9.1       Safety       28         9.2       EMC       28         10.       Packing       29         10.1       Definition of Label       29         10.2       Packing Methods       30         10.3       Pallet and Shipment Information       31         11.       Precautions       32         11.1.       Mounting Precautions       32         11.2.       Operating Precautions       32         11.3.       Operating Condition for Public Information Display       33         11.4.       Electrostatic Discharge Control       33         11.5.       Precautions for Strong Light Exposure       34         11.6.       Storage       34         11.7.       Handling Precautions for Protection Film       34         11.8.       Dust Resistance       34	6.	В	acklight Specification2	20
6.3       Power Sequence for Backlight       23         7.       Mechanical Characteristics       24         8.       Reliability Test Items       27         9.       International Standard       28         9.1       Safety       28         9.2       EMC       28         10.       Packing       29         10.1       Definition of Label       29         10.2       Packing Methods       30         10.3       Pallet and Shipment Information       31         11.       Precautions       32         11.1.       Mounting Precautions       32         11.2.       Operating Precautions       32         11.3.       Operating Condition for Public Information Display       33         11.4.       Electrostatic Discharge Control       33         11.5.       Precautions for Strong Light Exposure       34         11.6.       Storage       34         11.7.       Handling Precautions for Protection Film       34         11.8.       Dust Resistance       34	6.	1	Electrical specification	20
7. Mechanical Characteristics       24         8. Reliability Test Items       27         9. International Standard       28         9.1 Safety       28         9.2 EMC       28         10. Packing       29         10.1 Definition of Label       29         10.2 Packing Methods       30         10.3 Pallet and Shipment Information       31         11. Precautions       32         11.1. Mounting Precautions       32         11.2. Operating Precautions       32         11.3. Operating Condition for Public Information Display       33         11.4. Electrostatic Discharge Control       33         11.5. Precautions for Strong Light Exposure       34         11.6. Storage       34         11.7. Handling Precautions for Protection Film       34         11.8. Dust Resistance       34	6.	2	Input Pin Assignment2	21
8. Reliability Test Items       27         9. International Standard       28         9.1 Safety       28         9.2 EMC       28         10. Packing       29         10.1 Definition of Label       29         10.2 Packing Methods       30         10.3 Pallet and Shipment Information       31         11. Precautions       32         11.1. Mounting Precautions       32         11.2. Operating Precautions       32         11.3. Operating Condition for Public Information Display       33         11.4. Electrostatic Discharge Control       33         11.5. Precautions for Strong Light Exposure       34         11.6. Storage       34         11.7. Handling Precautions for Protection Film       34         11.8. Dust Resistance       34	6.	3	Power Sequence for Backlight	23
9. International Standard       28         9.1 Safety       28         9.2 EMC       28         10. Packing       29         10.1 Definition of Label       29         10.2 Packing Methods       30         10.3 Pallet and Shipment Information       31         11. Precautions       32         11.1. Mounting Precautions       32         11.2. Operating Precautions       32         11.3. Operating Condition for Public Information Display       33         11.4. Electrostatic Discharge Control       33         11.5. Precautions for Strong Light Exposure       34         11.6. Storage       34         11.7. Handling Precautions for Protection Film       34         11.8. Dust Resistance       34	7.	M	echanical Characteristics2	24
9.1       Safety       28         9.2       EMC       28         10.       Packing       29         10.1       Definition of Label       29         10.2       Packing Methods       30         10.3       Pallet and Shipment Information       31         11.       Precautions       32         11.1       Mounting Precautions       32         11.2       Operating Precautions       32         11.3       Operating Condition for Public Information Display       33         11.4       Electrostatic Discharge Control       33         11.5       Precautions for Strong Light Exposure       34         11.6       Storage       34         11.7       Handling Precautions for Protection Film       34         11.8       Dust Resistance       34	8.			
9.2 EMC       28         10. Packing       29         10.1 Definition of Label       29         10.2 Packing Methods       30         10.3 Pallet and Shipment Information       31         11. Precautions       32         11.1. Mounting Precautions       32         11.2. Operating Precautions       32         11.3. Operating Condition for Public Information Display       33         11.4. Electrostatic Discharge Control       33         11.5. Precautions for Strong Light Exposure       34         11.6. Storage       34         11.7. Handling Precautions for Protection Film       34         11.8. Dust Resistance       34	9.	In	ternational Standard2	28
10. Packing       29         10.1 Definition of Label       29         10.2 Packing Methods       30         10.3 Pallet and Shipment Information       31         11. Precautions       32         11.1. Mounting Precautions       32         11.2. Operating Precautions       32         11.3. Operating Condition for Public Information Display       33         11.4. Electrostatic Discharge Control       33         11.5. Precautions for Strong Light Exposure       34         11.6. Storage       34         11.7. Handling Precautions for Protection Film       34         11.8. Dust Resistance       34	9.	1	Safety2	28
10.1       Definition of Label       29         10.2       Packing Methods       30         10.3       Pallet and Shipment Information       31         11.       Precautions       32         11.1       Mounting Precautions       32         11.2       Operating Precautions       32         11.3       Operating Condition for Public Information Display       33         11.4       Electrostatic Discharge Control       33         11.5       Precautions for Strong Light Exposure       34         11.6       Storage       34         11.7       Handling Precautions for Protection Film       34         11.8       Dust Resistance       34	9.	2	EMC	28
10.2 Packing Methods       30         10.3 Pallet and Shipment Information       31         11. Precautions       32         11.1. Mounting Precautions       32         11.2. Operating Precautions       32         11.3. Operating Condition for Public Information Display       33         11.4. Electrostatic Discharge Control       33         11.5. Precautions for Strong Light Exposure       34         11.6. Storage       34         11.7. Handling Precautions for Protection Film       34         11.8. Dust Resistance       34	10.			
10.3 Pallet and Shipment Information3111. Precautions3211.1. Mounting Precautions3211.2. Operating Precautions3211.3. Operating Condition for Public Information Display3311.4. Electrostatic Discharge Control3311.5. Precautions for Strong Light Exposure3411.6. Storage3411.7. Handling Precautions for Protection Film3411.8. Dust Resistance34	10	0.1	Definition of Label	29
11.Precautions3211.1.Mounting Precautions3211.2.Operating Precautions3211.3.Operating Condition for Public Information Display3311.4.Electrostatic Discharge Control3311.5.Precautions for Strong Light Exposure3411.6.Storage3411.7.Handling Precautions for Protection Film3411.8.Dust Resistance34	10	0.2	Packing Methods	30
11.1. Mounting Precautions3211.2. Operating Precautions3211.3. Operating Condition for Public Information Display3311.4. Electrostatic Discharge Control3311.5. Precautions for Strong Light Exposure3411.6. Storage3411.7. Handling Precautions for Protection Film3411.8. Dust Resistance34	10	0.3	Pallet and Shipment Information	31
11.2. Operating Precautions       32         11.3. Operating Condition for Public Information Display       33         11.4. Electrostatic Discharge Control       33         11.5. Precautions for Strong Light Exposure       34         11.6. Storage       34         11.7. Handling Precautions for Protection Film       34         11.8. Dust Resistance       34	11.	Pı	recautions	32
11.3. Operating Condition for Public Information Display 33   11.4. Electrostatic Discharge Control 33   11.5. Precautions for Strong Light Exposure 34   11.6. Storage 34   11.7. Handling Precautions for Protection Film 34   11.8. Dust Resistance 34	11	l.1.	Mounting Precautions	32
11.4. Electrostatic Discharge Control       33         11.5. Precautions for Strong Light Exposure       34         11.6. Storage       34         11.7. Handling Precautions for Protection Film       34         11.8. Dust Resistance       34	11	l.2.	Operating Precautions	32
11.5. Precautions for Strong Light Exposure	11	1.3.	Operating Condition for Public Information Display	33
11.6. Storage	11	1.4.	Electrostatic Discharge Control	33
11.6. Storage				
11.7. Handling Precautions for Protection Film34 11.8. Dust Resistance34	11	l.6.	Storage	34
11.8. Dust Resistance34	11	1.7.	Handling Precautions for Protection Film	34
12. Appendix: Content Format36		l.8.	Dust Resistance	34
		ΑĮ	ppendix: Content Format	36



# **Record of Revision**

Version	Date	Page	Description							
0.0	2019/09/26	All	Final version release							
		7	Update color coordinates							
		10	Update input power							
0.4	0040/40/04	20	Modify inrush current: 2→16.1							
0.1	2019/10/04	23	Modify T3: 410→200							
		24	Weight: TBD→6.4							
		26	Update 2D drawing							
		4	Correct "Outline Dimension": 1232.4(H)x363(V)x10.7(D)→1232.4(H)x363 (V)x25.1(D)							
		7	Modify "Color Coordinates"							
0.2	2019/12/17	27	Height of packing drop: 25.4→45.7cm							
30 Modify packing me		30	Modify packing method: CB on top side							
		22	LED DB connector → LED DB connector (CN2)							
0.2	2020/02/44	12	Correct the diagram of Input equivalent impedance of LVDE_SEL pin							
0.3	2020/02/11	25, 26	Update 2D drawing							
		60,	120							
	7 Modify "Col 27 Height of p 30 Modify pack 22 LED DB col 0.3 2020/02/11 T2 Correct the									
			ontia on							
			afide Use							
			Comman							
			The Tures E. Vo.							
			TEC 16							
			12,3000,							
		COY	201							
			tial only							
			edeli ice							
			50m - 21 - 1							



## 1. General Description

This specification applies to the 49.5 inch Color TFT-LCD Module P495IVN01.0. This LCD module has a TFT active matrix type liquid crystal panel 1920x540 pixels, and diagonal size of 49.5 inch. This module supports 1920x540 mode. Each pixel is divided into Red, Green and Blue sub-pixels or dots which are arranged in vertical stripes. Gray scale or the brightness of the sub-pixel color is determined with a 8-bit gray scale signal for each dot.

P495IVN01.0 has been designed to apply the 8-bit 2 channel LVDS interface method. It is intended to support displays where high brightness, wide viewing angle, high color saturation, and high color depth are very important. Special material applied into this model is advanced wide temperature LC(-40°C~110°C).

#### \* General Information

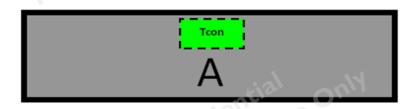
Outline Dimension 1232.4(H) x  Driver Element a-Si TFT  Display Colors 8 b	49.5 inch  H) x 340.2(V) mm  363(V) x 25.1(D) mm  active matrix  t(16.7 million) Colors	D: front bezel to D/B cover
Outline Dimension 1232.4(H) x  Driver Element a-Si TFT  Display Colors 8 b	363(V) x 25.1(D) mm active matrix	D: front bezel to D/B cover
Driver Element a-Si TFT Display Colors 8 b	active matrix	D: front bezel to D/B cover
Display Colors 8 b	100	
	t(16.7 million) Colors	
Number of Pixels 19		
	20 x 540 Pixel	
Pixel Pitch 0.63 (H	) x 0.63 (W) mm	
Pixel Arrangement RGB v	ertical stripe	
Display Operation Mode Norm	nally Black	
Surface Treatment Anti-	Glare, 3H	Haze ≤ 3%
Rotate Function Una	chievable	Note 1
Display Orientation Portrait/Lar	dscape Enabled	Note 2
Operating Time	24/7	See Chapter 11.3 for details
Frame Rate	60 Hz	See Chapter 5.1 for details
LED Life	70K hours	See Chapter 6.1 for details



Note 1: Rotate Function refers to LCD display could be able to rotate. This function does not work in this model. Note 2:

- (1) Landscape Mode: The default placement is T-Con Side on the upside and the image is shown upright via viewing from the front.
- (2) Portrait Mode: The default placement is that T-Con side has to be placed on the right side via viewing from the front.

## Landscape (Front view)



## Portrait (Front view)





## 2. Absolute Maximum Ratings

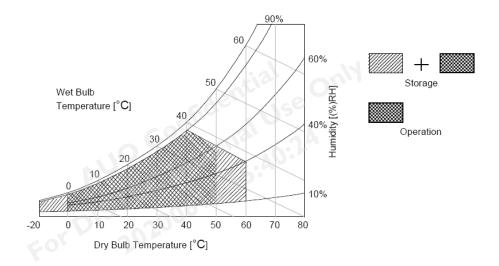
The followings are maximum values which, if exceeded, may cause faulty operation or damage to the unit

Item	Symbol	Min	Max	Unit	Conditions
Logic/LCD Drive Voltage	$V_{DD}$	-0.3	14	[Volt]	Note 1
Input Voltage of Signal	Vin	-0.3	4	[Volt]	Note 1
Operating Temperature	TOP	0	50	[°C]	Note 2
Operating Humidity	HOP	10	90	[%RH]	Note 2
Storage Temperature	TST	-20	+60	[°C]	Note 2
Storage Humidity	HST	10	90	[%RH]	Note 2
Panel Surface Temperature	PST		65	[°C]	Note 3

Note 2 : Maximum Wet-Bulb should be 39°C and No condensation.

The relative humidity must not exceed 200°C. The relative humidity must not exceed 90% non-condensing at temperatures of 40°C or less. At temperatures greater than 40°C, the wet bulb temperature must not exceed 39°C

Note 3: Surface temperature is measured at 50° C Dry condition

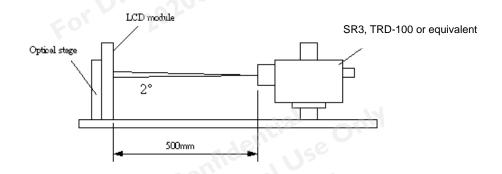




# 3. Optical Specification

Optical characteristics are determined after the unit has been 'ON' and stable for approximately 45 minutes in a dark environment at 25°C. The values specified are at an approximate distance 500 mm from the LCD surface at a viewing angle of  $\varphi$  and  $\theta$  equal to  $0^\circ$ .

Fig.1 presents additional information concerning the measurement equipment and method.



	Parameter	Cymphol	Inco	Values		Unit	Notes
	Parameter	Symbol	Min.	Тур.	Max	Unit	notes
Contras	t Ratio	CR	3200	4000			1
Surface	Luminance (White)	Lwh	1200	1500		cd/m <sup>2</sup>	2
Luminar	nce Variation	<b>б</b> wніте(9Р)			1.33		3
Respon	se Time (G to G)	Тү		8	16	ms	4
Color G	amut	sRGB		72	4	%	
Gamma	l	Gma	1.9	2.2	2.5		
Color C	oordinates		egen	160			
	Red	R <sub>X</sub>		0.606			
		Ry	rerm	0.326			
	Green	Gx	100	0.337	-		
	Green	Gy	Turn 0.02	0.559	T. m. 10.02		
	Blue	Bx	Тур0.03	0.165	Typ.+0.03		
	60,	B <sub>Y</sub>		0.112	-		
	White	Wx		0.313			
		W <sub>Y</sub>		0.329			
Viewing	Angle				1.1		5
	x axis, right(φ=0°)	$\theta_{r}$		89		degree	
	x axis, left(φ=180°)	θι	ege.	89		degree	
	y axis, up(φ=90°)	$\theta_{u}$		89		degree	
	y axis, down (φ=270°)	$\theta_{\sf d}$	Ler's	89		degree	



Note:

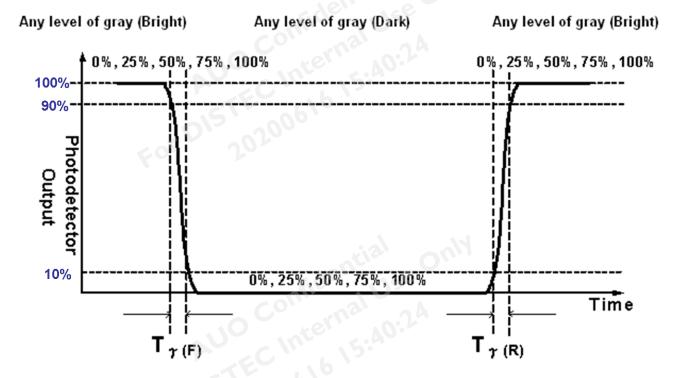
1. Contrast Ratio (CR) is defined mathematically as:

- 2. Surface luminance is luminance value at point 5 across the LCD surface 50cm from the surface with all pixels displaying white. From more information see FIG 2. LED current I<sub>F</sub> = typical value (without driver board), LED input VDDB =24V, I<sub>DDB</sub>. = Typical value (with driver board), L<sub>WH</sub>=Lon5 where Lon5 is the luminance with all pixels displaying white at center 5 location.
- 3. The variation in surface luminance,  $\delta$ WHITE is defined (center of Screen) as:  $\delta_{\text{WHITE(9P)}} = \text{Maximum}(L_{on1}, L_{on2}, ..., L_{on9}) / \text{Minimum}(L_{on1}, L_{on2}, ... L_{on9})$
- 4. Response time  $T_{\gamma}$  is the average time required for display transition by switching the input signal for five luminance ratio (0%,25%,50%,75%,100% brightness matrix) and is based on Frame rate = 60Hz to optimize.

Me	asured	Target											
Respo	nse Time	0%	25%	50%	75%	100%							
	0%		0% to 25%	0% to 50%	0% to 75%	0% to 100%							
25%		25% to 0%		25% to 50%	25% to 75%	25% to 100%							
Start	50%	50% to 0%	50% to 25%		50% to 75%	50% to 100%							
	75%	75% to 0%	75% to 25%	75% to 50%		75% to 100%							
	100%	100% to 0%	100% to 25%	100% to 50%	100% to 75%								

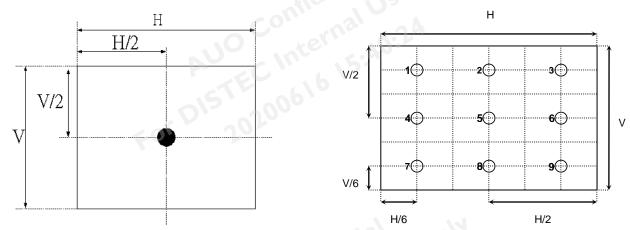
Ty is determined by 10% to 90% brightness difference of rising or falling period. (As illustrated)

The response time is defined as the following figure and shall be measured by switching the input signal for "any level of gray(bright)" and "any level of gray(dark)".



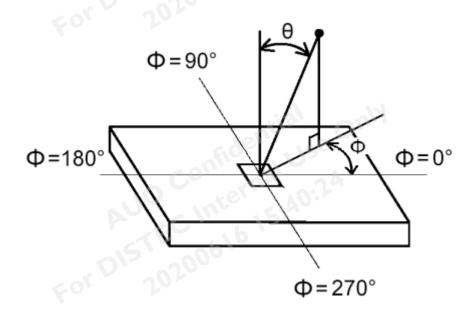


#### FIG. 2 Luminance



5. Viewing angle is the angle at which the contrast ratio is greater than 10. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG3.

## FIG.3 Viewing Angle





# 4. Interface Specification

## 4.1 Input power

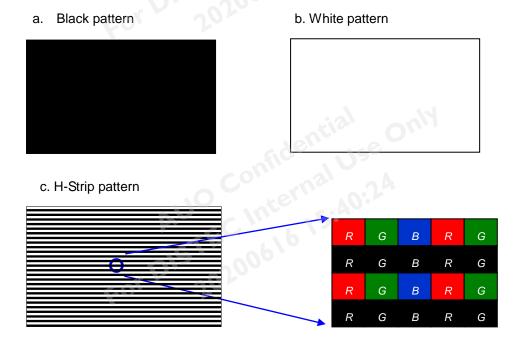
The P495IVN01.0 module requires power inputs which are employed to power the LCD electronics and to drive the TFT array and liquid crystal.

Item	TEC	Symbol	Min.	Тур.	Max	Unit	Note
Power Supply Input Voltage	0/2,000	$V_{DD}$	10.8	12	13.2	V	1
E	Black pattern		-	0.34	0.41	Α	
Power Supply Input Current	White pattern	$I_{DD}$	-	0.35	0.42	Α	
	H-strip pattern		-	0.41	0.49	Α	2
	Black pattern		-	4.08	4.90	Watt	
Power Consumption	White pattern	Pc	21-	4.20	5.04	Watt	
	H-strip pattern	cyenc	150	4.92	5.90	Watt	
Inrush Current	C0 <sup>V</sup>	I <sub>RUSH</sub>	0_		2.86	А	3

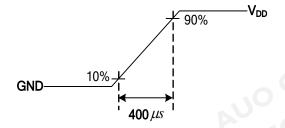
**Note1.** The ripple voltage should be fewer than 5% of VDD.

**Note2.** Test Condition:

- (1)  $V_{DD} = 12.0V$ , (2)  $F_{V} = 60Hz$ , (3)  $F_{C} = 74.25MHz$ , (4)  $T_{C} = 25 ^{\circ}C$
- (5) Power dissipation check pattern. (Only for power design)



**Note3.** Measurement condition : Rising time = 400us





## 4.2 Input Connection

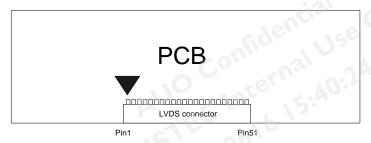
LCD connector:

P-Two 187059-51221-1 / Starconn 115E51-0000RA-M3-R / JAE SJ11346-FI-RTE51SZ-HF

PIN	Symbol	Description / 0	Note	PIN	Symbol	Description	Note
1	N.C.	No connection	1&2	26	N.C.	No connection	2
2	N.C.	No connection	2	27	N.C.	No connection	2
3	N.C.	No connection	2	28	CH2_0-	LVDS Channel 2, Signal 0-	
4	N.C.	No connection	2	29	CH2_0+	LVDS Channel 2, Signal 0+	
5	N.C.	No connection	2	30	CH2_1-	LVDS Channel 2, Signal 1-	
6	N.C.	No connection	2	31	CH2_1+	LVDS Channel 2, Signal 1+	
7	LVDS_SEL	Open/ Low (GND) for NS High (3.3V) for JEIDA	3&4	32	CH2_2-	LVDS Channel 2, Signal 2-	
8	N.C.	No connection	2	33	CH2_2+	LVDS Channel 2, Signal 2+	
9	N.C.	No connection	2	34	GND	Ground	
10	N.C.	No connection	2	35	CH2_CLK-	LVDS Channel 2, Clock -	
11	GND	Ground	rel	36	CH2_CLK+	LVDS Channel 2, Clock +	
12	CH1_0-	LVDS Channel 1, Signal 0-	. 6	37	GND	Ground	
13	CH1_0+	LVDS Channel 1, Signal 0+	6/10	38	CH2_3-	LVDS Channel 2, Signal 3-	
14	CH1_1-	LVDS Channel 1, Signal 1-		39	CH2_3+	LVDS Channel 2, Signal 3+	
15	CH1_1+	LVDS Channel 1, Signal 1+		40	N.C.	No connection	2
16	CH1_2-	LVDS Channel 1, Signal 2-		41	N.C.	No connection	2
17	CH1_2+	LVDS Channel 1, Signal 2+		42	N.C.	No connection	2
18	GND	Ground		43	N.C.	No connection	2
19	CH1_CLK-	LVDS Channel 1, Clock -		44	GND	Ground	
20	CH1_CLK+	LVDS Channel 1, Clock +	60	45	GND	Ground	
21	GND	Ground		46	GND	Ground	
22	CH1_3-	LVDS Channel 1, Signal 3-	yes,	47	N.C.	No connection	2
23	CH1_3+	LVDS Channel 1, Signal 3+	\ h	48	$V_{DD}$	Power Supply Input Voltage	
24	N.C.	No connection	2	49	$V_{DD}$	Power Supply Input Voltage	
25	N.C.	No connection	2	50	$V_{DD}$	Power Supply Input Voltage	
		Y		51	$V_{DD}$	Power Supply Input Voltage	



## Note1. Pin number start from the left side as the following figure.



Note2. Please leave this pin unoccupied. It cannot be connected with any signal (Low/GND/High).

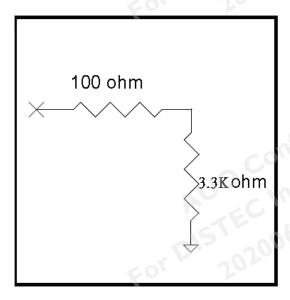
## Note3. Input control signal threshold voltage definition

Item	Symbol	Min.	Тур.	Max.	Unit
Input High Threshold Voltage	VIH	2.7	-	3.6	٧
Input Low Threshold Voltage	VIL	0	7 t-10.1	0.6	V

#### Note4. LVDS data format selection

LVDS_SEL	Mode
L or OPEN	NS
Н	Jeida

Input equivalent impedance of LVDE\_SEL pin



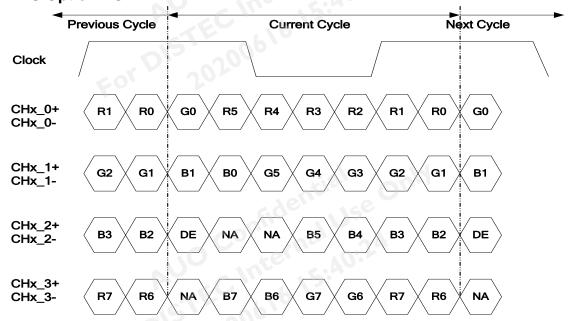


## 4.3 Input Data Format

## 4.3.1 LVDS color data mapping

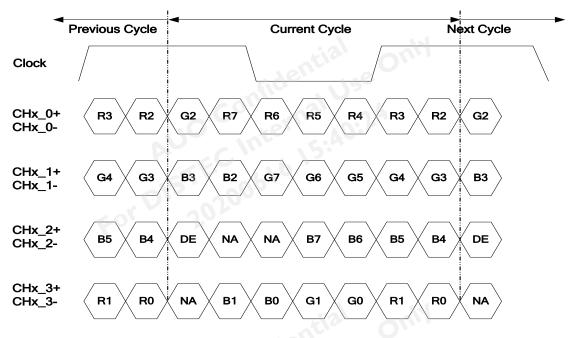
## **LVDS Option for 8bit**

## ■ LVDS Option NS



Note: x = 1, 2, 3, 4...

## **■ LVDS Option JEIDA**



Note: x = 1, 2, 3, 4...

## 4.3.2 Color Input Data Reference

The brightness of each primary color (red, green and blue) is based on the 8 bit gray scale data input for the color; the higher the binary input, the brighter the color. The table below provides a reference for color versus data input.

**COLOR** DATA REFERENCE

23) 1023) 223)	MS R9 0 1 0 0 1	R8 0 1 0 0	R7 0 1 0 0	0 1 0	R5 0 1 0	1	0 1 0	R2 0 1		SB R0 0 1	G9 0 0	SB G8 0	G7 0 0	ı	GRE G5 0			G2 0			MS B9		B7 0	B6 0	BL B5		B3 0	B2 0		SB B(
1023)	R9 0 1 0 0 0	R8 0 1 0 0	0 1 0	0 1 0	0 1 0	0 1 0	0 1 0	0	R1 0 1	R0 0 1	G9 0 0	G8 0	0	0	0				G1	G0	В9	B8							B1	г –
1023)	0 1 0 0 0	0 1 0 0	0 1 0	0 1 0	0 1 0	0 1 0	0 1 0	0	0	0	0	0	0	0	0															B
1023)	1 0 0 0	1 0 0	1 0	1 0 0	1	1	1	1	1	1	0			<u> </u>		0	0	0	0	0	0	0	0	0	0	0	0	0	Λ	
1023)	0 0 0	0 0 0	0	0	0	0	0		<u> </u>	ļ		0	0	Λ															U	0
)23)	0	0	0	0				0	0	0			<del> </del>	U	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
·	0	0			0	0	^		†**********	ļ	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0
а	1		0	^			0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1
a		4		0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
	4	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1
	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0
	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
00)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
01)	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
)22)	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
023)	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
1(000)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
l(001)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0
											O																			
l(1022)	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0
l(1023)	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0
000)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
001)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1
022)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	0
023)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1
1 1 0	22) 23) (000) (001) (1022) (1023) 00) 01)	(1022) 0 (1023) 0 (1023) 0 (101) 0	(1022) 0 0 (1023) 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0	(1022) 0 0 0 (1023) 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0	22)       1       1       1       1         23)       1       1       1       1         (000)       0       0       0       0         (001)       0       0       0       0         (1022)       0       0       0       0         (1023)       0       0       0       0         00)       0       0       0       0         01)       0       0       0       0         022)       0       0       0       0	(000)       0 <td>22)       1</td> <td>22)       1       0       0       0       0</td> <td>22)       1</td> <td>22)       1</td> <td>22)       1</td> <td>22)         1         0</td> <td>22)         1         0</td> <td>  22)</td> <td>22)         1         0         0         0         0           (000)         0<!--</td--><td>22)       1       1       1       1       1       1       1       1       1       1       1       0</td><td>22)         1</td><td>  22)</td><td>  22)</td><td>  22</td><td>22)         1         0</td><td>22)         1         0</td><td>22)         1         0</td><td>22)         1         0</td><td>22) 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1</td><td>22)         1         0</td><td>22) 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1</td><td>22) 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1</td><td>22) 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1</td><td>22) 1 1 1 1 1 1 1 1 1 1 1 1 1 0 0 0 0 0 0</td></td>	22)       1	22)       1       0       0       0       0	22)       1	22)       1	22)       1	22)         1         0	22)         1         0	22)	22)         1         0         0         0         0           (000)         0 </td <td>22)       1       1       1       1       1       1       1       1       1       1       1       0</td> <td>22)         1</td> <td>  22)</td> <td>  22)</td> <td>  22</td> <td>22)         1         0</td> <td>22)         1         0</td> <td>22)         1         0</td> <td>22)         1         0</td> <td>22) 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1</td> <td>22)         1         0</td> <td>22) 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1</td> <td>22) 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1</td> <td>22) 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1</td> <td>22) 1 1 1 1 1 1 1 1 1 1 1 1 1 0 0 0 0 0 0</td>	22)       1       1       1       1       1       1       1       1       1       1       1       0	22)         1	22)	22)	22	22)         1         0	22)         1         0	22)         1         0	22)         1         0	22) 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	22)         1         0	22) 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	22) 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	22) 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	22) 1 1 1 1 1 1 1 1 1 1 1 1 1 0 0 0 0 0 0

# 5. Signal Timing Specification

This is the signal timing required at the input of the user connector. All of the interface signal timing should be satisfied with the following specifications for its proper operation.

## 5.1 Input Timing

## 5.1.1. Timing table

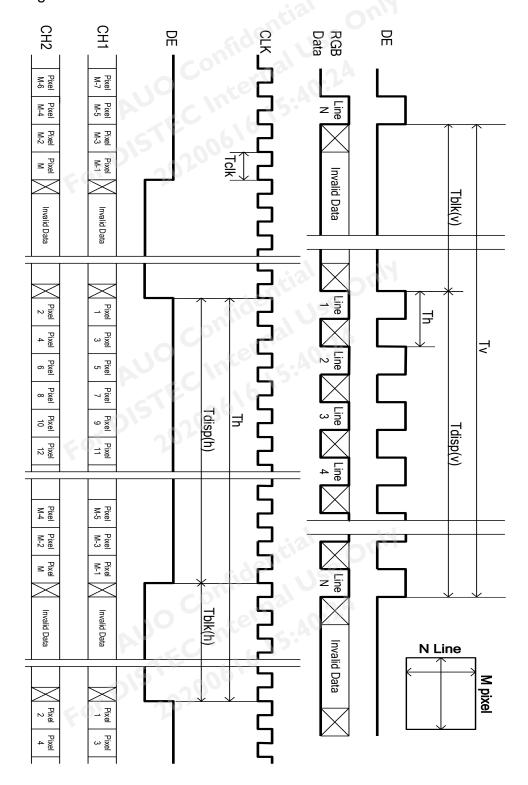
## **Timing Table (DE only Mode)**

Signal	Item	Symbol	Min.	Тур.	Max	Unit
	Period	Tv	1120	1125	1480	Th
Vertical Section	Active	Tdisp (v)	4	1080		
	Blanking	Tblk (v)	40	45	400	Th
	Period	Th	1030	1100	1325	Tclk
Horizontal Section	Active	Tdisp (h)		960		
	Blanking	Tblk (h)	70	140	365	Tclk
Clock	Frequency	Fclk=1/Tclk	53	74.25	82	MHz
Vertical Frequency	Frequency	Fv	47	60	63	Hz
Horizontal Frequency	Frequency	Fh	60	67.5	73	KHz

#### Notes:

- (1) Display position is specific by the rise of DE signal only.
  Horizontal display position is specified by the rising edge of 1<sup>st</sup> DCLK after the rise of 1<sup>st</sup> DE, is displayed on the left edge of the screen.
- (2) Vertical display position is specified by the rise of DE after a "Low" level period equivalent to eight times of horizontal period. The 1<sup>st</sup> data corresponding to one horizontal line after the rise of 1<sup>st</sup> DE is displayed at the top line of screen.
- (3) If a period of DE "High" is less than 1920 DCLK or less than 1080 lines, the rest of the screen displays black.
- (4) The display position does not fit to the screen if a period of DE "High" and the effective data period do not synchronize with each other.

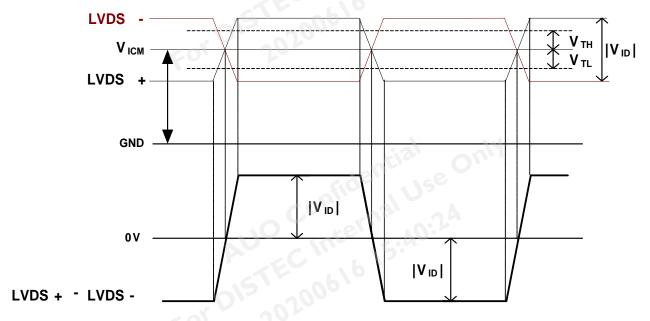
## 5.1.2. Signal Timing Waveform



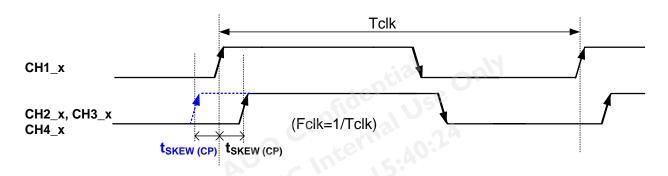
## 5.2 Input interface characteristics

Parameter		Symbol	Value			Unit	Note
		Symbol	Min.	Тур.	Max	Offic	Note
	Input Differential Voltage	V <sub>ID</sub>	200	400	600	mV <sub>DC</sub>	1
	Differential Input High Threshold Voltage	V <sub>тн</sub>	+100		+300	mV <sub>DC</sub>	1
	Differential Input Low Threshold Voltage	V <sub>TL</sub>	-300		-100	mV <sub>DC</sub>	1
	Input Common Mode Voltage	VICM	1.1	1.25	1.4	V <sub>DC</sub>	1
LVDS	Input Channel Pair Skew Margin	t <sub>SKEW (CP)</sub>	-500		+500	ps	2
Interface	Receiver Clock : Spread Spectrum  Modulation range	Fclk_ss	Fclk	<u>.</u>	Fclk +3%	MHz	3
	Receiver Clock : Spread Spectrum Modulation frequency	Fss	30		200	KHz	3
	Receiver Data Input Margin Fclk = 85 MHz Fclk = 65 MHz	tRMG	-0.4 -0.5	 	0.4 0.5	ns	8

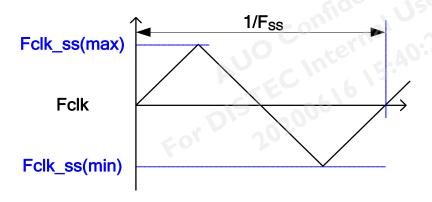
Note1. VICM = 1.25V



Note2. Input Channel Pair Skew Margin

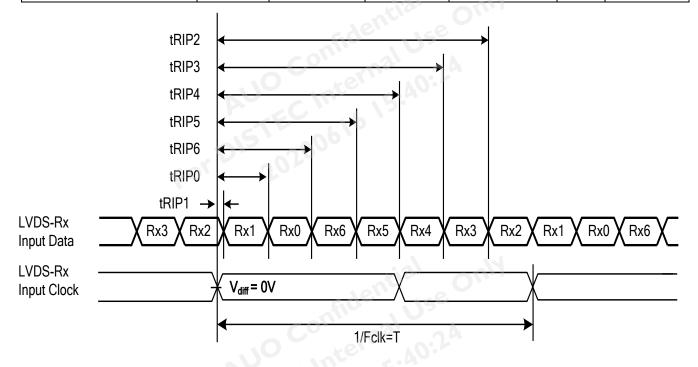


Note3. LVDS Receiver Clock SSCG (Spread spectrum clock generator) is defined as below figures.

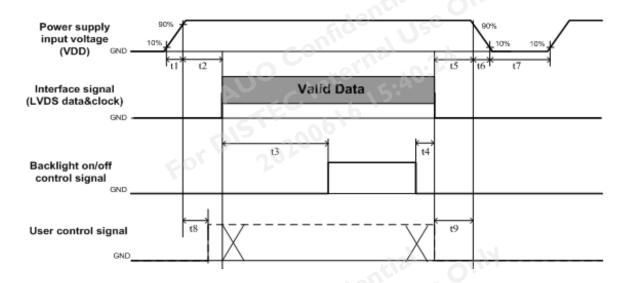


Note4. Receiver Data Input Margin

Danamatan	Comple of	e d	Rating			Nata
Parameter	Symbol	Min	Туре	Max	Unit	Note
Input Clock Frequency	Fclk	Fclk (min)	40.4	Fclk (max)	MHz	T=1/Fclk
Input Data Position0	tRIP1	- tRMG	0	tRMG	ns	
Input Data Position1	tRIP0	T/7- tRMG	T/7	T/7+ tRMG	ns	
Input Data Position2	tRIP6	2T/7- tRMG	2T/7	2T/7+ tRMG	ns	
Input Data Position3	tRIP5	3T/7- tRMG	3T/7	3T/7+ tRMG	ns	
Input Data Position4	tRIP4	4T/7- tRMG	4T/7	4T/7+ tRMG	ns	
Input Data Position5	tRIP3	5T/7- tRMG	5T/7	5T/7+ tRMG	ns	
Input Data Position6	tRIP2	6T/7- tRMG	6T/7	6T/7+ tRMG	ns	



## 5.3 Power Sequence for LCD



Davamatar	6.0	I locit		
Parameter	Min.	Type.	Max.	Unit
t1	0.4	1.5	30	ms
t2	40	6/0		ms
t3	640			ms
t4	0*1			ms
t5	0			ms
t6			*2	ms
t7	1000		Ya	ms
t8	20 <sup>*3</sup>	eder- 15e	50	ms
t9	0	71		ms

#### Note:

- (1) t4=0 : concern for residual pattern before BLU turn off.
- (2) t6: voltage of VDD must decay smoothly after power-off. (Customer system decide this value)
- (3) When User control signal is N.C. (no connection), opened in Transmitted end, t8 timing spec can be negligible.

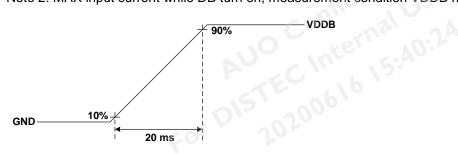
# 6. Backlight Specification

## **Electrical specification**

6.	Backlight Specification  6.1 Electrical specification								
	6.1 Electrical specification								
	Item	S	ymbol	Condition	Min	Тур	Max	Unit	Note
1	Power Supply Input Voltage	V	/DDB	16-	22.8	24	25.2	V	-
2	Power Supply Input Current		I <sub>DDB</sub>	VDDB=24V		3.67	4.38	Α	1
3	Power Consumption		P <sub>DDB</sub>	VDDB=24V		88.1	105	Watt	1
4	Inrush Current		Irush	VDDB=24V			16.1	Α	2
5	Control signal voltage	V <sub>Signal</sub>	Hi	VDDB=24V	2	-	5.5	V	-
	Control Signal Voltage	▼ Signai	Low	VDDD=24V	0	-	0.8	V	3
6	Control signal current		Signal	VDDB=24V	-	-	1.5	mA	-
7	External PWM Duty ratio (input duty ratio)	D_	EPWM	VDDB=24V	0	-	100	%	4
8	External PWM Frequency	F	EPWM	VDDB=24V	120	-	960	Hz	4
9	DET status signal	DET	HI	VDDB=24V	Оре	en Colle	ctor	V	5
9	DET status signal	DLI	Lo	VDDB=24V	0	-	0.8	V	5
10	Input Impedance		Rin	VDDB=24V	300			Kohm	-
11	LED lifetime	Ľ	TLED	-	70,000	-	-	Hr	6

Note 1: Dimming ratio= 100%, (Ta=25±5°C, Turn on for 45minutes)

Note 2: MAX input current while DB turn on, measurement condition VDDB rising time=20ms(VDDB: 10%~90%)



Note 3: When BLU off ( VDDB = 24V, VBLON = 0V), IDDB (max) = 0.1A.

Note 4: Less than 5% dimming control is functional well and no backlight shutdown happened.

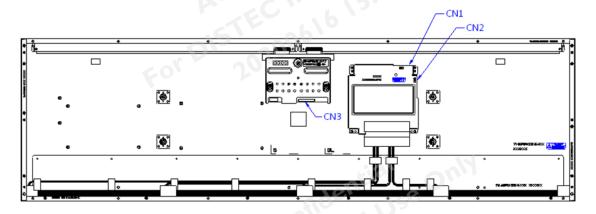
Note 5: Normal: 0~0.8V; Abnormal: Open collector.

Note 6: The lifetime (MTTF) is defined as the time which luminance of LED is 50% compared to its original value. [Operating condition: Continuous operating at Ta = 25±2°C, for single LED only]

## 6.2 Input Pin Assignment

The P495IVN01.0 module requires 1 power input (14-pin).

CN1 & CN2 (BLU Driver Board)
CN3 (TCON Board)



■ LED DB connector (CN1): No connection (for AUO internal use only)

Pin	Symbol	Description	Note
1	NC	No connection	4
2	NC	No connection	4
3	NC	No connection	4
4	NC	No connection	4
5	NC	No connection	4
6	NC	No connection	4
7	NC	No connection	4
8	NC	No connection	4
9	NC	No connection	4
10	NC	No connection	4
11	NC	No connection	4
12	NC	No connection	4
13	NC	No connection	4
14	NC	No connection	4

## LED DB connector (CN2): CI0114M1HRL-NH(CviLux) or equivalent

Pin	Symbol	Description	Note
1	VDDB	Power Supply Input Voltage	
2	VDDB	Power Supply Input Voltage	
3	VDDB	Power Supply Input Voltage	
4	VDDB	Power Supply Input Voltage	
5	VDDB	Power Supply Input Voltage	
6	GND	Ground	
7	GND	Ground	
8	GND	Ground	
9	GND	Ground	
10	GND	Ground	
11	DET	BLU status detection:	1
12	VBLON	BLU On-Off control:	2,3
13	NC S	NC	4
14	PDIM	External PWM	2

## Note1. DET status

DET	BLU status
0 ~ 0.8V	Normal
Open collector	Abnormal

	DET	BLU status						
	0 ~ 0.8V	Normal						
	Open collector	Abnormal						
Recomm	end pull high R > 10	K ohm, pull hi	gh voltage	VDD =	3.3V			
Note2. ir	nput control signal	threshold vo	Itage defi	nition				
Note2. ir	nput control signal	threshold vo	Itage defi	nition Min.	Тур.	Max.	Unit	
Note2. ir	-				Typ.	Max. 5.5	Unit V	

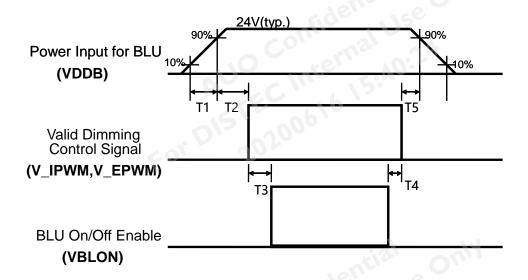
#### Note3. VBLON

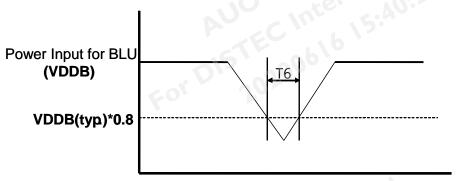
Mode selection

VBLON	Note
H or OPEN	BL On
L	BL Off

Note4. Please leave this pin unoccupied. It cannot be connected by any signal (Low/GND/High).

## 6.3 Power Sequence for Backlight





Dip condition

ondition		afidenti	use Only	
Parameter	Min	Тур	Max	Units
T1	20	10,50	70.	ms
T2	250	1.6	-	ms
Т3	200	00,		ms
T4	0 0	-	-	ms
T5	0	-	-	ms
Т6		-	1000	ms <sup>*1</sup>

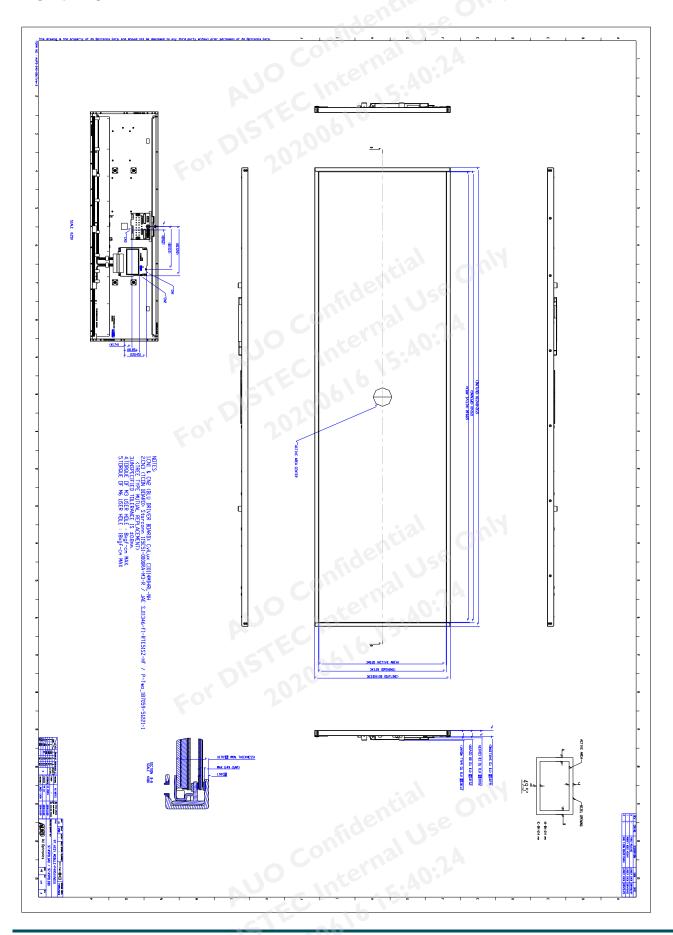
Note1. T6 describes VDDB dip condition and VDDB couldn't lower than 10% VDDB.

## 7. Mechanical Characteristics

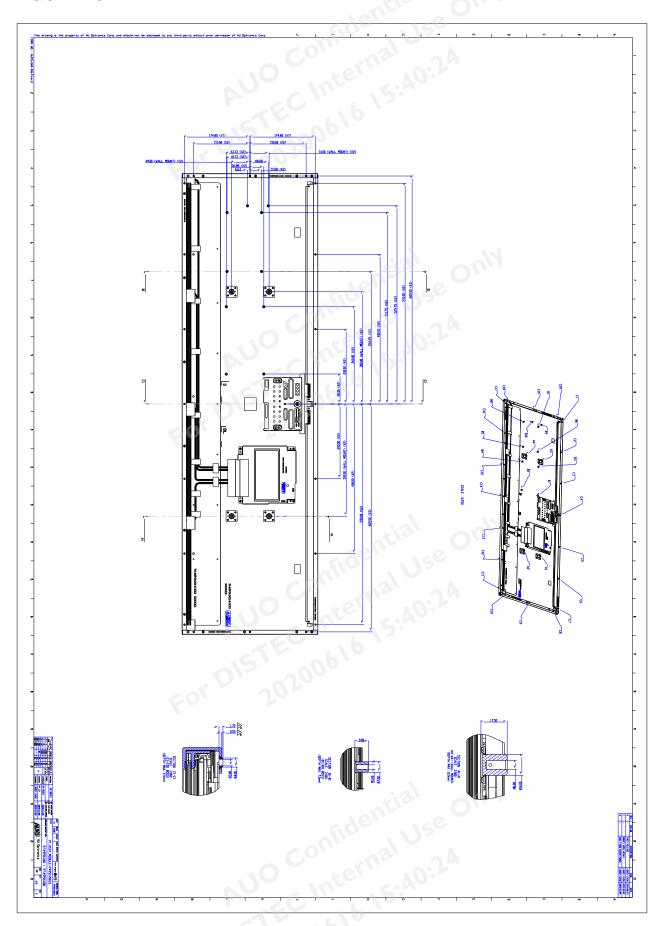
The contents provide general mechanical characteristics for the model P495IVN01.0. In addition the figures in the next page are detailed mechanical drawing of the LCD.

Item		Dimension	Unit	Note
	Horizontal	1232.4	mm	
	Vertical	363	mm	
	Depth (Dmin)	10.7	mm	Front bezel to rear
Outline Dimension	Depth (Dmax)	25.1	mm	Front Bezel to DB Cover
	Bezel opening	1212.6(H) x 343.2(V)	mm	
	Bezel Width	9.9/9.9/9.9/9.9	mm	U/D/L/R
	Display Area	1209.6(H) x 340.2(V)	mm	
Weight	6.4		Kg	

# **Front View**



## **Back View**



# 8. Reliability Test Items

	Test Item	Q'ty	Condition
Н	ligh temperature storage test	3	60°C, 500hrs
2 L	ow temperature storage test	3	-20°C, 500hrs
3 H	ligh temperature operation test	3	50°C, 500hrs
5 L	ow temperature operation test	3	-10°С, 500hrs
6 V	ibration test (With carton)	1( PKG)	Random wave (1.04Grms 2~200Hz)  Duration: X,Y,Z 20min per axes
· D	rop test (With carton)	1( PKG)	Height: 45.7 cm  Direction: 1-corner \ 3-edges \ 6-flats  (ASTMD4169-I)
8 V	ibration	2006 C Jul	Time: 5hr(each Axis)  Total time: 15hrs  Orientation:  a) Vertical: 4.25m/s²  b) Transverse:2.09m/s²  c) Longitudinal: 2.83m/s²

## 9. International Standard

## 9.1 Safety

- (1) UL 60950-1; Standard for Safety of Information Technology Equipment Including electrical Business Equipment.
- (2) IEC 60950-1; Standard for Safety of International Electrotechnical Commission
- (3) EN 60950-1; European Committee for Electrotechnical Standardization (CENELEC), EUROPEAN STANDARD for Safety of Information Technology Equipment Including Electrical Business Equipment.

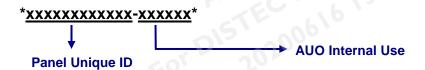
#### 9.2 EMC

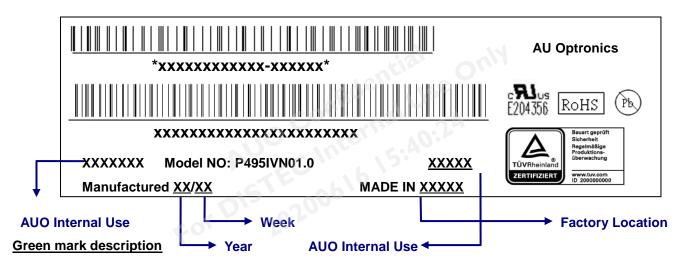
- (1) ANSI C63.4 "Methods of Measurement of Radio-Noise Emissions from Low-Voltage Electrical and Electrical Equipment in the Range of 9kHz to 40GHz. "American National standards Institute(ANSI), 1992
- (2) C.I.S.P.R "Limits and Methods of Measurement of Radio Interface Characteristics of Information Technology Equipment." International Special committee on Radio Interference.
- (3) EN 55022 "Limits and Methods of Measurement of Radio Interface Characteristics of Information Technology Equipment." European Committee for Electrotechnical Standardization. (CENELEC), 1998

## 10. Packing

## 10.1 Definition of Label

#### A. Panel Label:



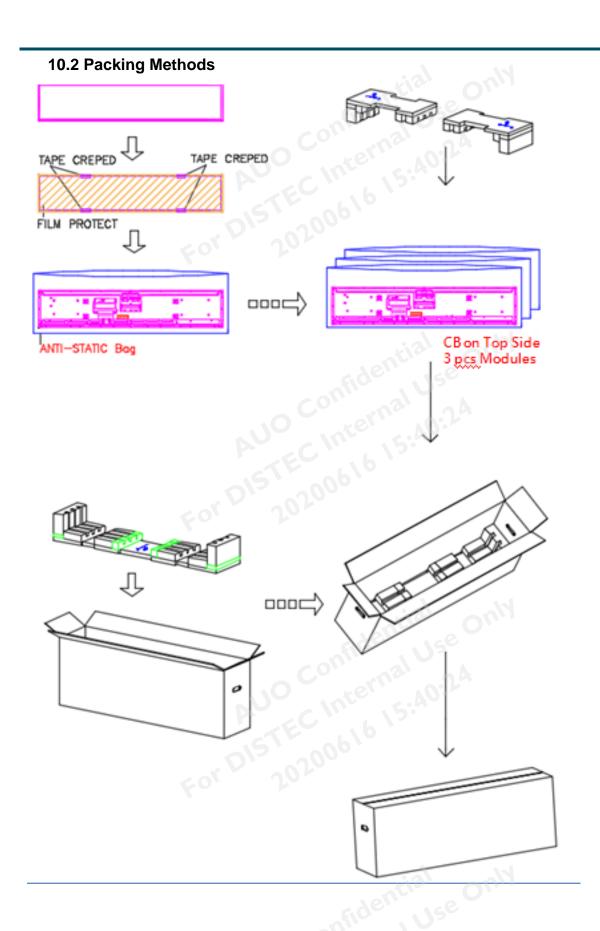


- (1) For Pb Free Product, AUO will add (Pb) for identification.
- (2) For RoHs compatible products, AUO will add RoHS for identification.

Note: The green Mark will be present only when the green documents have been ready by AUO internal green team. (definition of green design follows the AUO green design checklist.)

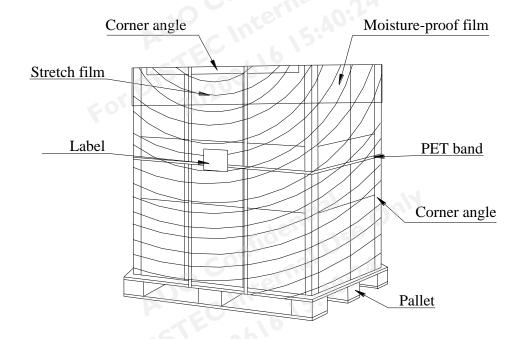
## **B. Carton Label:**





## 10.3 Pallet and Shipment Information

	Itom		Dooking Domork			
	Item	Qty.	Dimension	Weight (kg)	Packing Remark	
1	Packing BOX	3pcs/box	1350*310*502	25	Box =2.5 kg	
					Cushion=1.5 kg	
2	Pallet	119	1360*940*138	20	Pallet	
3	Boxes per Pallet	50x 30				
4	Panels per Pallet					
	Pallet after packing	1	1360*940*1644	245		



## 11. Precautions

Please pay attention to the followings when you use this TFT LCD module.

## 11.1. Mounting Precautions

- (1) You must mount a module using holes arranged in four corners or four sides.
- (2) You should consider the mounting structure so that uneven force (ex. twisted stress) is not applied to module. And the case on which a module is mounted should have sufficient strength so that external force is not transmitted directly to the module.
- (3) Please attach the surface transparent protective plate to the surface in order to protect the polarizer. Transparent protective plate should have sufficient strength in order to the resist external force.
- (4) You should adopt radiation structure to satisfy the temperature specification.
- (5) Acetic acid type and chlorine type materials for the cover case are not desirable because the former generates corrosive gas of attacking the polarizer at high temperature and the latter cause circuit broken by electro-chemical reaction.
- (6) Do not touch, push or rub the exposed polarizer with glass, tweezers or anything harder than HB pencil lead. And please do not rub with dust clothes with chemical treatment. Do not touch the surface of polarizer for bare hand or greasy cloth. (Some cosmetics are detrimental to the polarizer.)
- (7) When the surface becomes dusty, please wipe gently with absorbent cotton or other soft materials like chamois soaks with petroleum benzene. Normal-hexane is recommended for cleaning the adhesives used to attach front/ rear polarizer. Do not use acetone, toluene and alcohol because they cause chemical damage to the polarizer.
- (8) Wipe off saliva or water drops as soon as possible. Their long time contact with polarizer causes deformations and color fading.
- (9) Do not open the case because inside circuits do not have sufficient strength.

## 11.2. Operating Precautions

- (1) The spike noise causes the mis-operation of circuits. It should be lower than following voltage: V=±200mV(Over and under shoot voltage)
- (2) Response time depends on the temperature. (In lower temperature, it becomes longer.)
- (3) Brightness depends on the temperature. (In lower temperature, it may become lower.) And in lower temperature, response time (required time that brightness is stable after turned on) becomes longer.
- (4) Be careful for condensation at sudden temperature change. Condensation makes damage to polarizer or electrical contacted parts. And after fading condensation, smear or spot will occur.
- (5) When fixed patterns are displayed for a long time, remnant image is likely to occur.
- (6) Module has high frequency circuits. Sufficient suppression to the electromagnetic

interference shall be done by system manufacturers. Grounding and shielding methods may be important to minimize the interface.

(7) The conductive material and signal cables are kept away from LED driver inductor to prevent abnormal display, sound noise and temperature rising.

## 11.3. Operating Condition for Public Information Display

The device listed in the product specification is designed and manufactured for PID (Public Information Display) application. To optimize module's lifetime and function, below operating usages are required.

- (1) Normal operating condition
  - A. Operating temperature: 0~50°C
  - B. Operating humidity: 10~90%
  - C. Display pattern: dynamic pattern (Real display).Note) Long-term static display would cause image sticking.
- (2) Operation usage to protect against image sticking due to long-term static display.
  - A. Suitable operating time: under 24 hours a day
  - B. Liquid Crystal refresh time is required. Cycling display between 5 minutes' information (static) display and 10 seconds' moving image.
  - C. Periodically change background and character (image) color.
  - D. Avoid combination of background and character with large different luminance.
- (3) Periodically adopt one of the following actions after long time display.
  - A. Running the screen saver (motion picture or black pattern)
  - B. Power off the system for a while
- (4) LCD system is required to place in well-ventilated environment. Adapting active cooling system is highly recommended.
- (5) Product reliability and functions are only guaranteed when the product is used under right operation usages. If product will be used in extreme conditions, such as high temperature/ humidity, display stationary patterns, or long operation time etc..., it is strongly recommended to contact AUO for filed application engineering advice. Otherwise, its reliability and function may not be guaranteed. Extreme conditions are commonly found at airports, transit stations, banks, stock market and controlling systems.

## 11.4. Electrostatic Discharge Control

Since a module is composed of electronic circuits, it is not strong to electrostatic discharge. Make certain that treatment persons are connected to ground through wristband etc. And don't touch interface pin directly.

## 11.5. Precautions for Strong Light Exposure

- (1) Strong light exposure causes degradation of polarizer and color filter.
- (2) To keep display function well as a digital signage application, especially the component of TFT is very sensitive to sunlight, it is necessary to set up blocking device protecting panel from radiation of ambient environment.

## 11.6. Storage

When storing modules as spares for a long time, the following precautions are necessary.

- (1) Store them in a dark place. Do not expose the module to sunlight or fluorescent light. Keep the temperature between 5°C and 35°C at normal humidity.
- (2) The polarizer surface should not come in contact with any other object. It is recommended that they be stored in the container in which they were shipped.
- (3) Storage condition is guaranteed under packing conditions.
- (4) The phase transition of Liquid Crystal in the condition of the low or high storage temperature will be recovered when the LCD module returns to the normal condition.

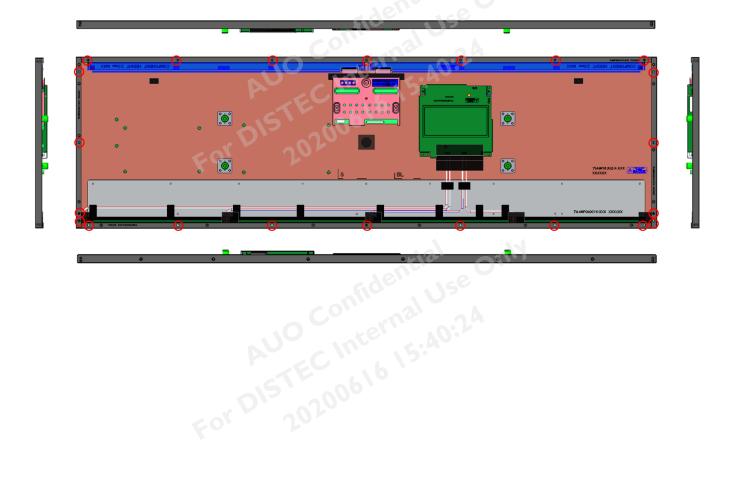
## 11.7. Handling Precautions for Protection Film

- (1) The protection film is attached to the bezel with a small masking tape. When the protection film is peeled off, static electricity is generated between the film and polarizer. This should be peeled off slowly and carefully by people who are electrically grounded and with well ion-blown equipment or in such a condition, etc.
- (2) When the module with protection film attached is stored for a long time, sometimes there remains a very small amount of glue still on the bezel after the protection film is peeled off.
- (3) You can remove the glue easily. When the glue remains on the bezel or its vestige is recognized, please wipe them off with absorbent cotton waste or other soft material like chamois soaked with normal-hexane.

## 11.8. Dust Resistance

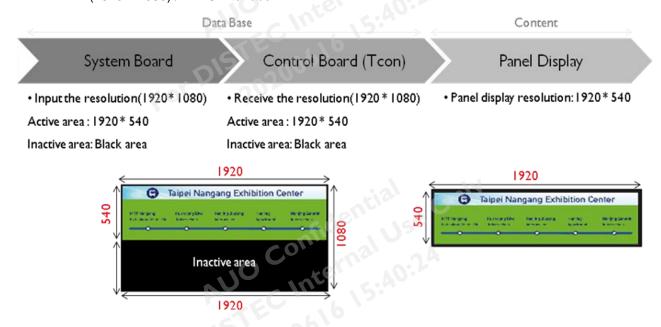
- (1) AUO module dust test is conducted with marked holes (see Figure 1) sealed to comply with JIS D0207.
- (2) Module users should design set with these holes used/sealed (if not used) or covered by set mechanism to prevent dust from entering. The AUO testing procedure cannot replicate all different real world scenarios, module users should apply set dust resistance solution to meet users' requirement.

Figure 1 (purple Circle mark)



## 12. Appendix: Content Format

■ FHD (1920 x 1080) / LVDS interface





Our company network supports you worldwide with offices in Germany, Austria, Switzerland, the UK and the USA. For more information please contact:

Headquarters

#### Germany





#### FORTEC Elektronik AG

Augsburger Str. 2b 82110 Germering

Phone: +49 89 894450-0
E-Mail: info@fortecag.de
Internet: www.fortecag.de

#### **Fortec Group Members**

#### Austria





#### Distec GmbH Office Vienna

Nuschinggasse 12 1230 Wien

Phone: +43 1 8673492-0
E-Mail: info@distec.de
Internet: www.distec.de

#### Germany





#### Distec GmbH

Augsburger Str. 2b 82110 Germering

Phone: +49 89 894363-0
E-Mail: info@distec.de
www.distec.de

## Switzerland





#### ALTRAC AG

Bahnhofstraße 3 5436 Würenlos

Phone: +41 44 7446111
E-Mail: info@altrac.ch
Internet: www.altrac.ch

#### **United Kingdom**





## Display Technology Ltd.

Osprey House, 1 Osprey Court Hichingbrooke Business Park Huntingdon, Cambridgeshire, PE29 6FN

Phone: +44 1480 411600

E-Mail: info@displaytechnology.co.uk
Internet: www.displaytechnology.co.uk

#### USA





#### Apollo Display Technologies, Corp.

87 Raynor Avenue, Unit 1Ronkonkoma, NY 11779

 Phone:
 +1 631 5804360

 E-Mail:
 info@apollodisplays.com

 Internet:
 www.apollodisplays.com